## **PRODUCT / PROCESS CHANGE INFORMATION**

	1. PCI basic data		
1.1 Company         STMicroelectronics International N.V		STMicroelectronics International N.V	
1.2 PCI No.		CRP/15/9379	
1.3 Title of PCI		SHIELDING BAG for SHENZHEN 4-layer Pre plated frame SO8 & TSSOP8 REELS AND TUBES	
1.4 Product Category		SO8N & TSSOP8 assembled with 4-layer Pre plated frame at ST Shenzhen	
1.5 Issue date		2015-09-03	

2. PCI Team		
2.1 Contact supplier		
2.1.1 Name	SETTLES JEFF	
2.1.2 Phone	+44 1628896222	
2.1.3 Email	jeff.settles@st.com	
2.2 Change responsibility		
2.2.1 Process Owner	Patrick LOW	
2.1.2 Corporate Quality Manager	Veronique LIVACHE	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape,	ST Shenzhen

4. Description of change		
	Old	New
4.1 Description	The reels and tubes of the 4-layer Pre plated frame SO8N & TSSOP8 packages from ST Shenzhen (China) are packed into the inner box without shielding bag.	The reels and tubes of the 4-layer Pre plated frame SO8N & TSSOP8 packages from ST Shenzhen (China) will be packed with a shielding bag into the inner box.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	<ul> <li>Form: Transparent shielding bag (packing material)</li> <li>Fit: N/A</li> <li>Function: N/A</li> </ul>	

5. Reason / motivation for change		
5.1 Motivation	This shielding bag will protect the product during exposure to uncontrolled environment before product usage (transportation/storage).	
5.2 Customer Benefit	QUALITY IMPROVEMENT	

6. Marking of parts / traceability of change		
6.1 Description	-	

7. Timing / schedule		
7.1 Date of qualification results	2015-08-21	
7.2 Intended start of delivery	2015-09-15	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
<b>QRMMY1513_external_rev1x.pdf</b>			
8.2 Qualification report and qualification results		Issue Date	2015-09-03

10. Affected parts				
10. 1 Current		10.2 New (if applicable)		
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No		
	M24128-BRMN6TP			
	M24256-BWMN6P			
	M24256-BWMN6TP			
	M24512-RMN6TP			
	M24512-WMN6TP			
	M24C01-WMN6P			
	M24C01-WMN6TP			
	M24C02-WMN6P			
	M24C04-WMN6P			
	M24C04-WMN6TP			
	M24C08-WMN6P			
	M24C16-WMN6P			
	M24C32-RDW6TP			
	M24C32-RMN6TP			
	M24C32-WMN6P			
	M24C32-WMN6TP			
	M24C64-WDW6TP			
	M24C64-WMN6P			
	M24C64-WMN6TP			
	M24LR04E-RMN6T/2			
	M24LR16E-RMN6T/2			
	M24LR64-RDW6T/2			
	M24M01-RMN6P			
	M24M01-RMN6TP			
	M24M02-DRMN6TP			
	M24SR02-YMN6T/2			
	M93C46-WMN6P			
	M93C56-WMN6P			
	M93C66-WMN6P			
	M93C86-MN6P			
	M93C86-WMN6P			
	M95020-RDW6TP			
	M95020-WMN6TP			
	M95128-WMN6P			
	M95256-WMN6P			
	M95320-WMN6P			
	M95640-WMN6P			

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